

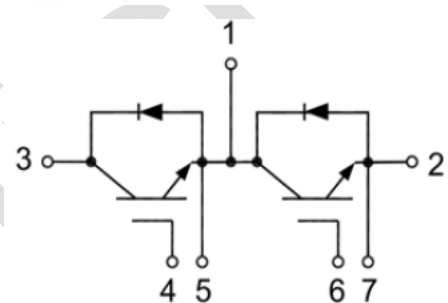
GT75HF120T1H-M

IGBT Module

Preliminary Data

Features:

- Field Stop Trench Gate IGBT
- Short Circuit Rated $> 10\mu\text{s}$
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested ($2 \times I_c$)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- Industrial Inverters
- Servo Applications

IGBT, Inverter

Maximum Rated Values ($T_C = 25^\circ\text{C}$ unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Continuous Collector Current	$T_C = 100^\circ\text{C}$	75	A
		$T_C = 25^\circ\text{C}$	150	A
I_{CM}	Peak Collector Current Repetitive	$T_J = 175^\circ\text{C}$	150	A
t_{SC}	Short Circuit Withstand Time		> 10	μs
P_D	Maximum Power Dissipation (IGBT)	$T_C = 25^\circ\text{C}$ $T_{Jmax} = 175^\circ\text{C}$	555	W

Electrical Characteristics of IGBT ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 2.6 \text{ mA}, V_{CE} = V_{GE}$	5.0	5.5	6.8	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 75\text{A}, V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	1.60		V
			$T_J = 125^\circ\text{C}$	1.80		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE} = 0\text{V}, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}, T_J = 25^\circ\text{C}$			200	nA
C_{ies}	Input Capacitance	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		7.5		nF
C_{res}	Reveres Transfer Capacitance			0.21		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 600\text{V}, I_C = 75\text{A}, R_G = 2\Omega, V_{GE} = \pm 15\text{V},$ Inductive Load	$T_J = 25^\circ\text{C}$	158		ns
			$T_J = 125^\circ\text{C}$	163		
t_r	Rise Time		$T_J = 25^\circ\text{C}$	49		ns
			$T_J = 125^\circ\text{C}$	53		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ\text{C}$	193		ns
			$T_J = 125^\circ\text{C}$	211		
t_f	Fall Time		$T_J = 25^\circ\text{C}$	204		ns
			$T_J = 125^\circ\text{C}$	371		
E_{on}	Turn-on Switching Loss		$T_J = 25^\circ\text{C}$	3.22		mJ
			$T_J = 125^\circ\text{C}$	4.35		
E_{off}	Turn-off Switching Loss	$T_J = 25^\circ\text{C}$	3.40		mJ	
		$T_J = 125^\circ\text{C}$	5.91			
Q_g	Total Gate Charge	$T_J = 25^\circ\text{C}$	374		nC	
RBSOA	RBSOA	$I_C = 150\text{A}, V_{CC} = 1050\text{V}, V_p = 1200\text{V}, R_g = 2\Omega, V_{GE} = +15\text{V to } 0\text{V}, T_J = 150^\circ\text{C}$	Trapezoid			
SC data	$V_{CC} = 800\text{V}, t_p = 10\mu\text{s}, V_{GE} = \pm 15\text{V}, R_g = 10\Omega, T_J = 25^\circ\text{C}$			469	A	
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case			0.27	$^\circ\text{C/W}$	

Diode, Inverter
Maximum Rated Values ($T_C = 25^\circ\text{C}$ unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	75	A
I_{FM}	Peak FWD Current Repetitive	150	A

Electrical Characteristics of FWD ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min	Typ	Max	Unit
V_{FM}	Forward Voltage	$I_F = 75\text{A}$	$T_J = 25^\circ\text{C}$		2.10	V
			$T_J = 125^\circ\text{C}$		2.20	
t_{rr}	Reverse Recovery Time		$T_J = 25^\circ\text{C}$		204	ns
			$T_J = 125^\circ\text{C}$		389	
I_{rr}	Peak Reverse Recovery Current	$I_F = 75\text{A}$, $-diF/dt = 1250\text{A}/\mu\text{s}$ $(T_J = 125^\circ\text{C})$	$T_J = 25^\circ\text{C}$		47.8	A
			$T_J = 125^\circ\text{C}$		64.7	
Q_{rr}	Reverse Recovery Charge	$V_{rr} = 600\text{V}$, $V_{GE} = -15\text{V}$	$T_J = 25^\circ\text{C}$		4.56	μC
			$T_J = 125^\circ\text{C}$		9.42	
E_{rec}	Reverse Recovery Energy		$T_J = 25^\circ\text{C}$		1.68	mJ
			$T_J = 125^\circ\text{C}$		3.60	
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case			0.43		$^\circ\text{C}/\text{W}$

Module

Symbol	Description	Conditions	Min	Typ	Max	Unit
V _{iso}	Isolation Voltage (All Terminals Shorted)	f = 50Hz, 1minute	2500			V
Internal Isolation			Al2O3			
Material of Module Baseplate			Copper			
L _{SCE}	Stray Inductance Module			30		nH
T _J	Maximum Junction Temperature				175	°C
T _{JOP}	Maximum Operating Junction Temperature Range		-40		+150	°C
T _{stg}	Storage Temperature		-40		+125	°C
CTI	Comparative Tracking Index		200			
R _{θCS}	Case-To-Sink Thermally (Conductive Grease Applied)			0.1		°C/W
T	Power Terminals Screw:M5		3.0		5.0	N·m
T	Mounting Screw:M6		4.0		6.0	N·m
G	Weight			135		g

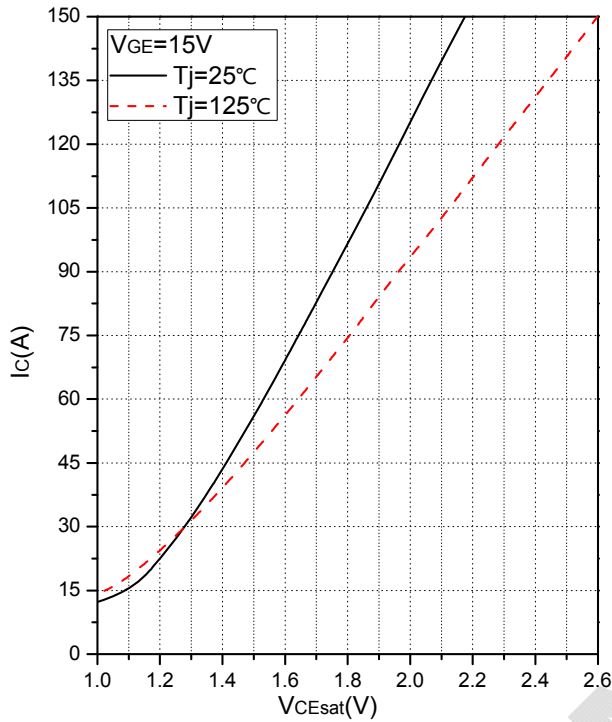


Fig.1 Typical Saturation Voltage Characteristics

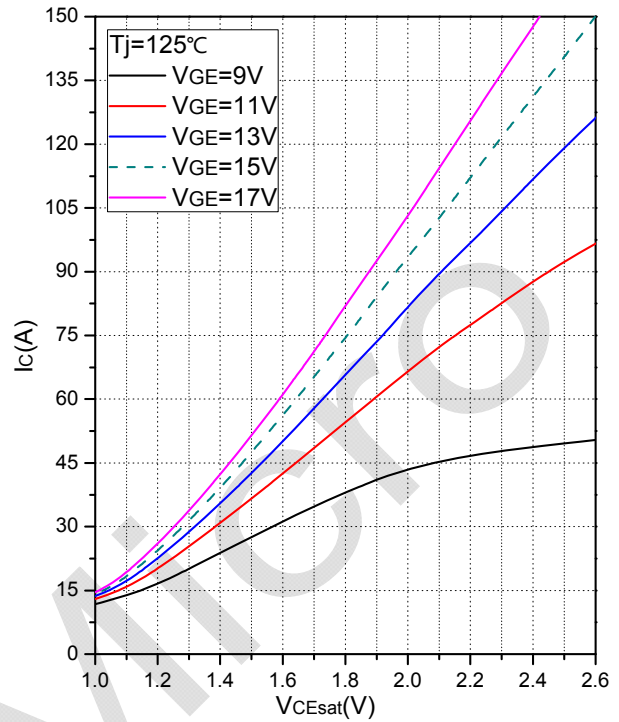


Fig.2 Typical Output Characteristics

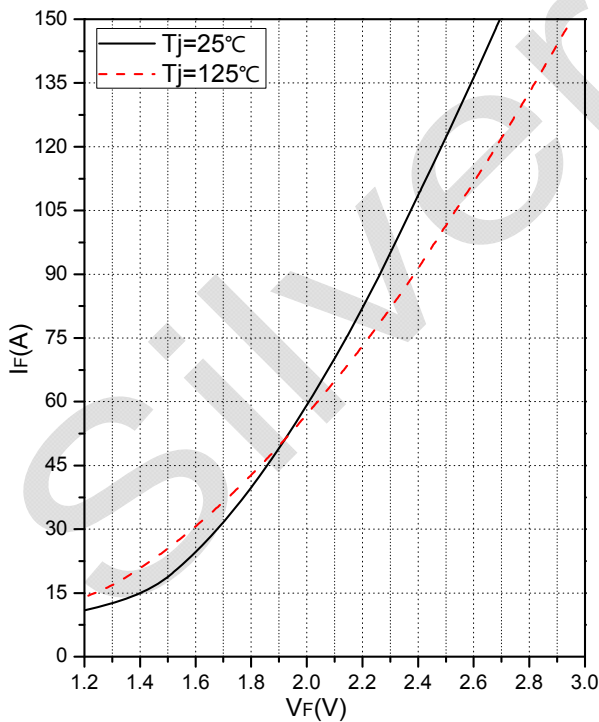


Fig.3 Forward Characteristics of FWD

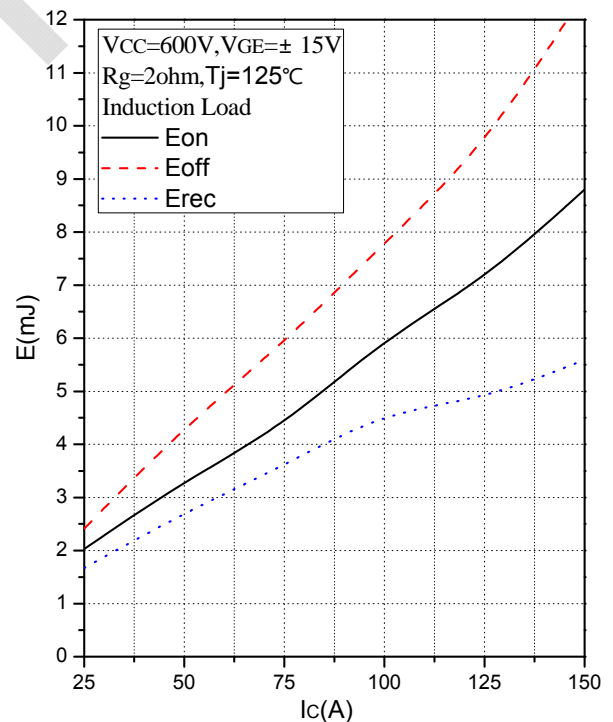


Fig.4 Typical Switching Loss vs. Collector Current

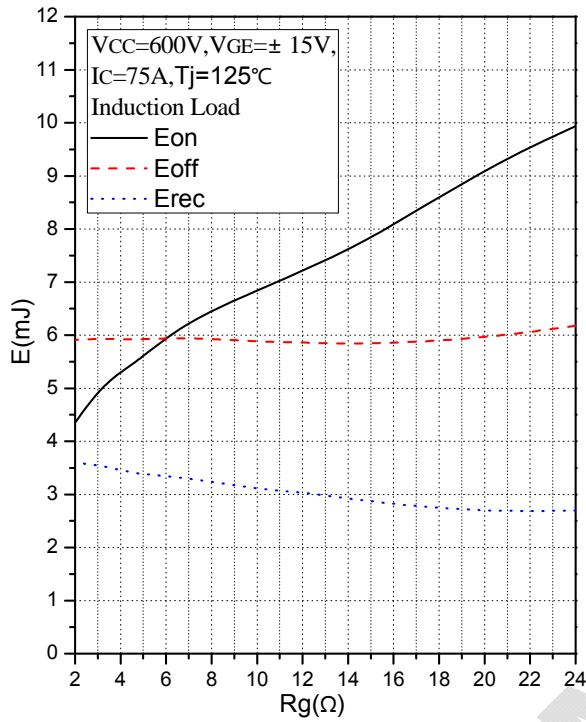


Fig.5 Typical Switching Loss vs. Gate Resistance

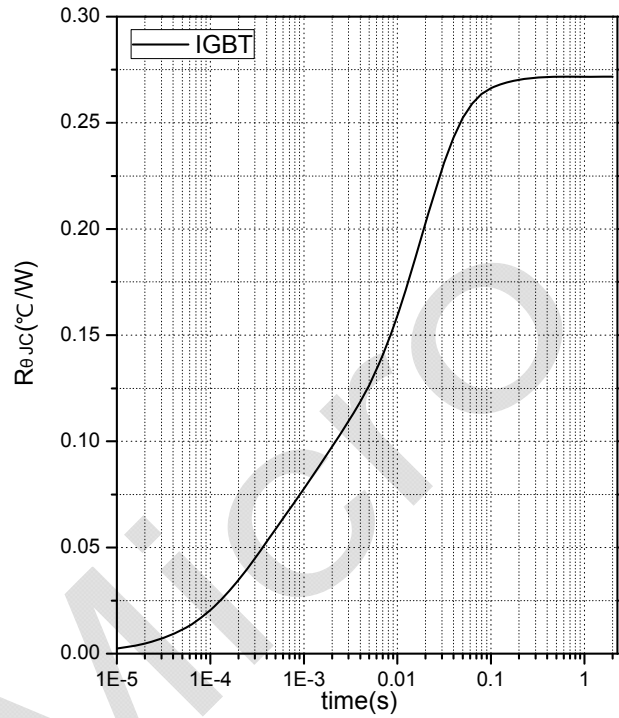


Fig.6 Transient Thermal Impedance

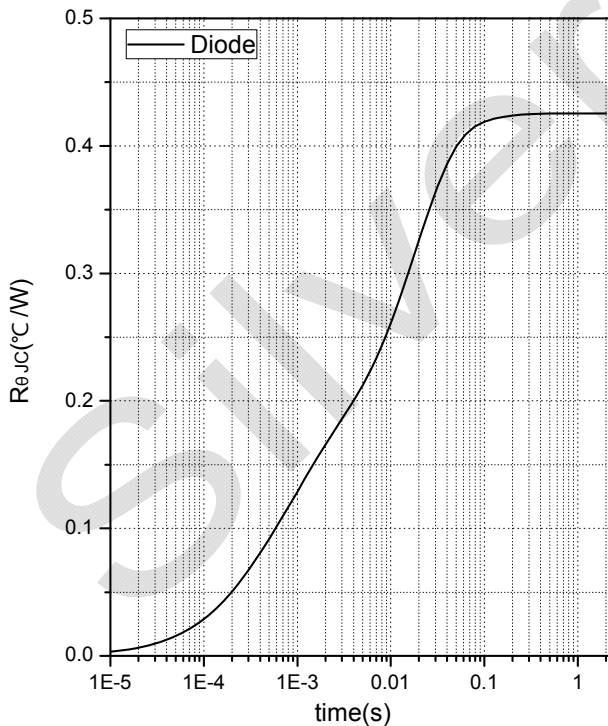


Fig.7 Transient Thermal Impedance

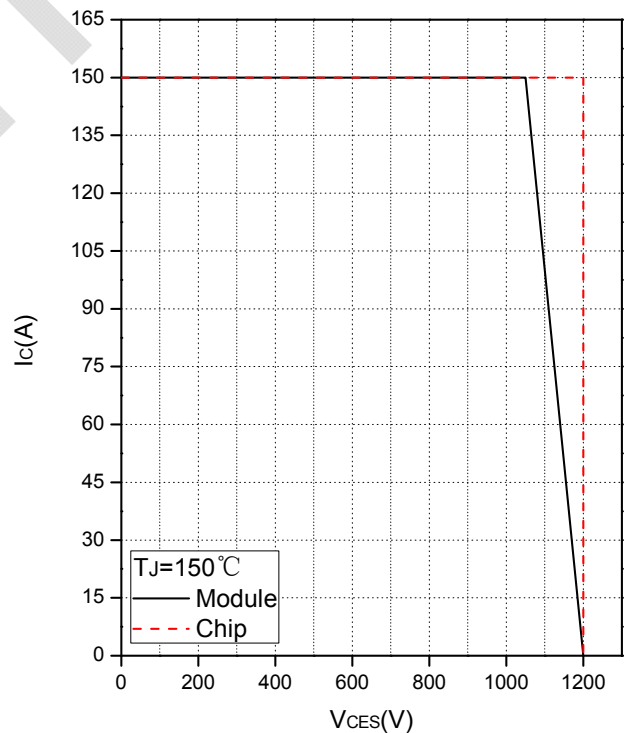


Fig.8 Reverse Bias Safe Operation Area (RBSOA)

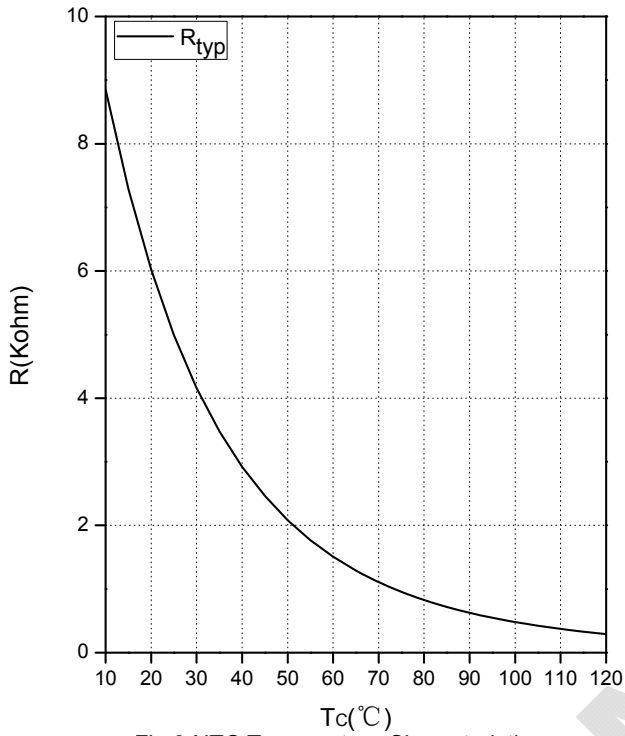


Fig.9 NTC Temperature Characteristics

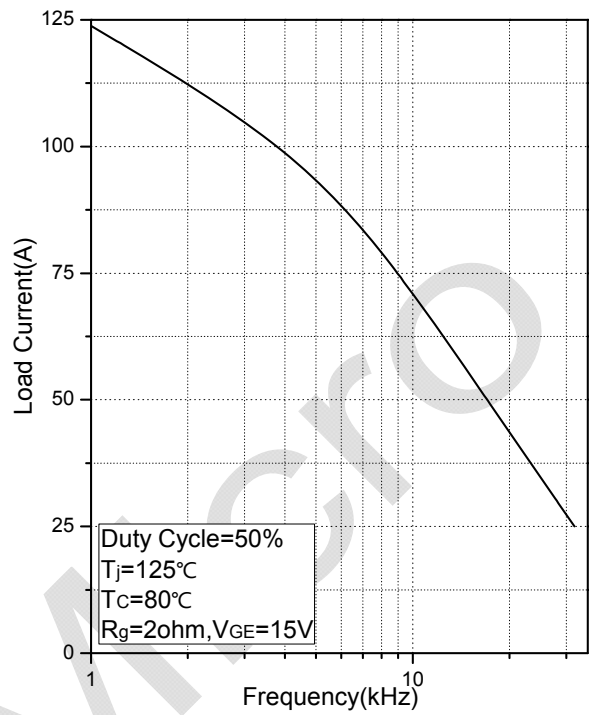
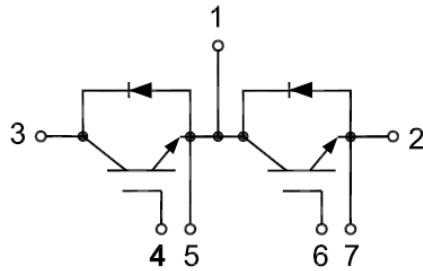
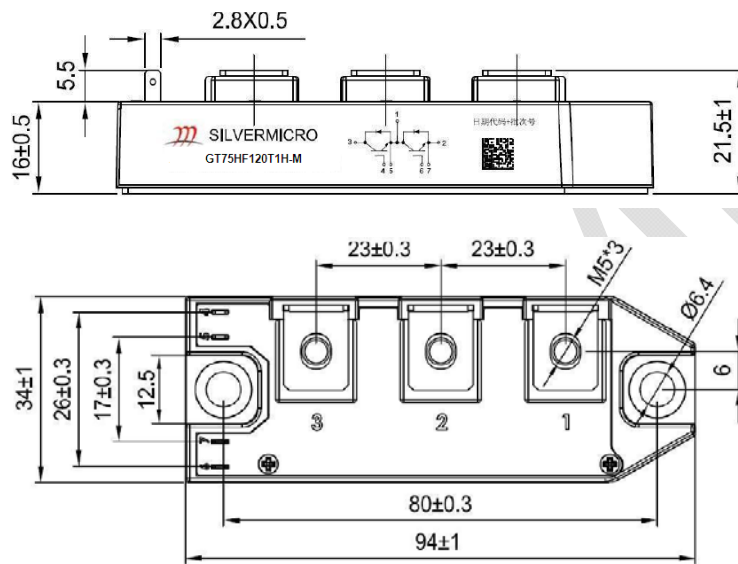


Fig.10 Typical Load Current vs. Frequency

Internal Circuit:



Package Outline (Unit: mm):





Date	Revision	Notes
05/14/2020	01	Initial Release

Announcement

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